FAIRCHILD

SEMICONDUCTOR\*

BSS138K

N-Channel Logic Level Enhancement Mode Field Effect Transistor

Features

• Low On-Resistance

- · Low Gate Threshold Voltage
- Low Input Capacitance
- · Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- · Pb Free/RoHS Compliant
- Green Compound
- ESD HBM=2000V as per JEDEC A114A ; ESD CDM = 2000V as per JEDEC C101C



### Absolute Maximum Ratings \* T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Value	Units
V <sub>DSS</sub>	Drain-Source Voltage		50	V
V <sub>GSS</sub>	Gate-Source Voltage		±12	V
۱ <sub>D</sub>	Drain Current	Continuous Pulsed	0.22 0.88	A
ТJ	Operating Junction Temperature Range		-55 to +150	°C
T <sub>STG</sub>	Storage Temperature Range		-55 to +150	°C

\* These ratings are limiting values above which the serviceability of any semiconductor device maybe impaired.

### **Thermal Characteristics**

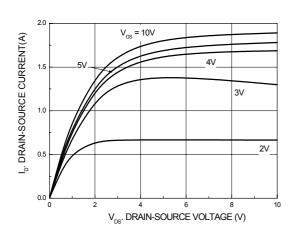
Symbol	Parameter	Value	Units
P <sub>D</sub>	Total Device Dissipation Derating above T <sub>A</sub> = 25°C	350 2.8	m₩ m₩/°C
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient *	350	°C/W

\* Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. Minimum land pad size

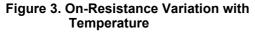
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Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, Ι <sub>D</sub> =10μΑ	50			V
BV <sub>DSS</sub> T <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D$ =250µA, Referenced to 25°C		0.11		V/∘C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0V			0.1	μA
I <sub>GSS</sub>	Gate-Body Leakage	$V_{GS}$ = ±12V, $V_{DS}$ = 0V $V_{GS}$ = ±10V, $V_{DS}$ = 0V $V_{GS}$ = ±5V, $V_{DS}$ = 0V			±1 ±0.5 ±0.05	μΑ
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	0.6		1.2	V
V <sub>GS(th)</sub> T <sub>J</sub>	Gate Threshold Voltage Temperature Coefficient	I <sub>D</sub> = 1mA, Referenced to 25°C		-1.4		mV/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance				2.5 2.0 1.6	Ω
I <sub>D(ON)</sub>	On-State Drain Current	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 5V	0.2			А
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10V, I <sub>D</sub> = 200mA	200			mS
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			58		
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ = 25V, $V_{GS}$ = 0V, f = 1.0MHz		9.75		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			5.2		
$R_{G}$	Gate Resistance	V <sub>DS</sub> = 5V, V <sub>GS</sub> = 10mV		281		Ω
Switching	g Characteristics					
t <sub>D(ON)</sub>	Turn-On Delay Time				5	
t <sub>r</sub>	Turn-On Rise Time	V <sub>DD</sub> = 30V, I <sub>D</sub> = 0.29A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω			5	- ns
t <sub>D(OFF)</sub>	Turn-Off Delay Time	$V_{GS} = 100, R_{GEN} = 002$			60	
t <sub>f</sub>	Turn-Off Fall Time				35	
Qg	Total Gate Change				2.4	
Q <sub>gs</sub>	Gate-Source Change	V <sub>DS</sub> = 25V, I <sub>D</sub> = 0.2A, V <sub>GS</sub> = 10V, I <sub>G</sub> = 0.1mA			0.5	nC
Q <sub>gd</sub>	Gate-Drain Change				0.5	
Drain-Soເ	urce Diode Characteristics and	d Maximum Ratings				
$V_{sd}$	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 115mA			1.2	V

# **Typical Performance Characteristics**



## Figure 1. On-Region Characteristics



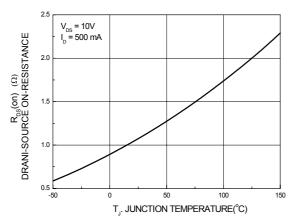


Figure 5. Transfer Characteristics

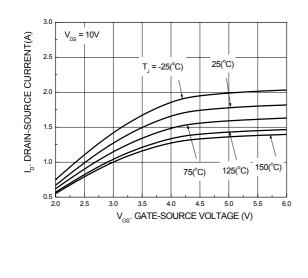
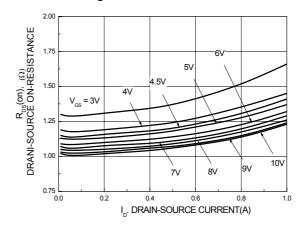


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current





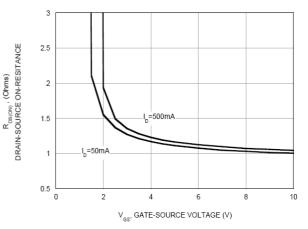
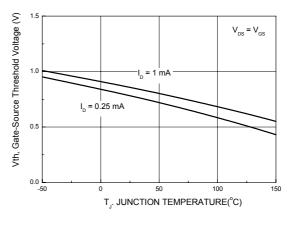
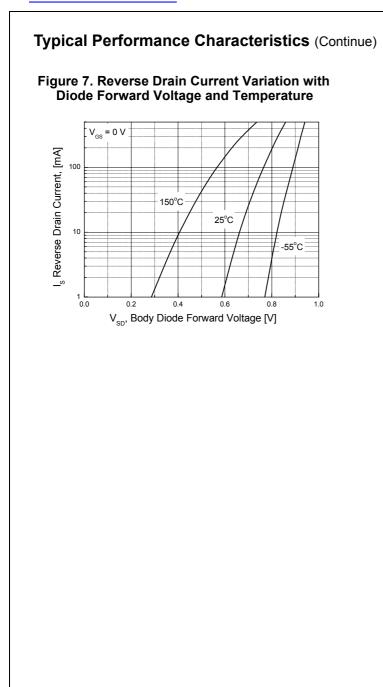


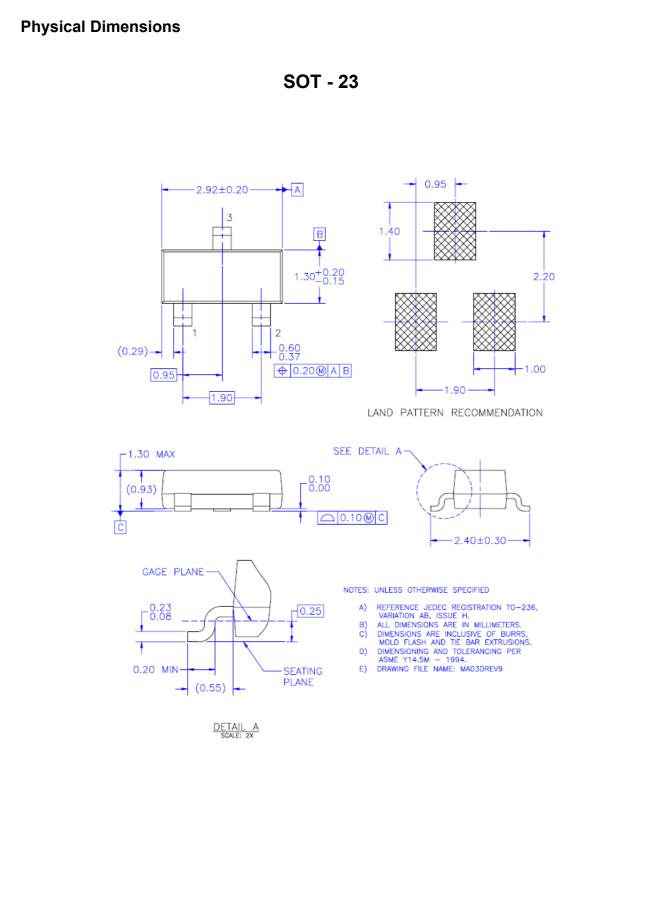
Figure 6. Gate Threshold Variation with Temperature



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